

TS MICROFINISH™

Specifications: Semiconductor Grade
 Seamless 316L Seamless 304 HASTELLOY C22*

TUBING ASTM-A-269		CLEANED FOR OXYGEN SERVICE	TUBING
1/8 × .020	1/2 × .065	3/4 × .065	1/4 × .035
1/8 × .028	5/8 × .049	1 × .065	3/8 × .035
1/8 × .035	3/4 × .065	1 1/2 × .065	1/2 × .049
1/4 × .035	1 × .065	2 × .065	
1/4 × .049	1 1/2 × .065	3 × .083	
3/8 × .305	2 × .065	4 × .083	
3/8 × .049	2 1/2 × .065		
1/2 × .035	3 × .065		
1/2 × .049	4 × .083		

Sizes listed above are in stock in the Microfinish condition appropriate for Process EP™ (Electropolish). Process EP tubing and piping will exhibit maximum internal surface roughness of 15 RMS microinches. Testing is done at our facility with a surface measuring device used in accordance with the governing standard ANSI B46.1 — 1978.

Please contact your local Tube Service Co. representative for further details regarding its Microfinish tubing, piping and fittings.

Tube Service Co. can meet your specialty requirements for ultraclean piping components used in semiconductor and other critical process gas systems. We can supply out of stock the tubing, piping, fittings and flanges appropriate for such systems. We are a direct mill distributor of Seamless 316L Grade tubing and piping that is specially ordered to our trademarked Microfinish™ specification.

*Internal surface RMS not guaranteed.

